

Description

This 28-bit 1:2 configurable registered buffer is designed for 1.7V to 1.9V VDD operation. All inputs are compatible with the JEDEC standard for SSTL_18, except the chip-select gate-enable (CSGEN), control (C), and reset ($\overline{\text{RESET}}$) inputs, which are LVCMOS. All outputs are edge-controlled circuits optimized for unterminated DIMM loads, and meet SSTL_18 specifications, except the open-drain error ($\overline{\text{QERR}}$) output.

The IDT74SSTUBF32868A operates from a differential clock (CLK and $\overline{\text{CLK}}$). Data are registered at the crossing of CLK going high and $\overline{\text{CLK}}$ going low. The device supports low-power standby operation. When $\overline{\text{RESET}}$ is low, the differential input receivers are disabled, and undriven (floating) data, clock, and reference voltage (Vref) inputs are allowed. In addition, when $\overline{\text{RESET}}$ is low, all registers are reset and all outputs are forced low except $\overline{\text{QERR}}$. The LVCMOS $\overline{\text{RESET}}$ and C inputs must always be held at a valid logic high or low level. To ensure defined outputs from the register before a stable clock has been supplied, $\overline{\text{RESET}}$ must be held in the low state during power up. In the DDR2 RDIMM application, $\overline{\text{RESET}}$ is specified to be completely asynchronous with respect to CLK and $\overline{\text{CLK}}$. Therefore, no timing relationship can be ensured between the two. When entering reset, the register will be cleared and the data outputs will be driven low quickly, relative to the time to disable the differential input receivers. However, when coming out of reset, the register will become active quickly, relative to the time to enable the differential input receivers. As long as the data inputs are low, and the clock is stable during the time from the low-to-high transition of $\overline{\text{RESET}}$ until the input receivers are fully enabled, the design of the IDT74SSTUBF32868A must ensure that the outputs will remain low, thus ensuring no glitches on the output.

The IDT74SSTUBF32868A includes a parity checking function. Parity, which arrives one cycle after the data input to which it applies, is checked on the PAR_IN input of the device. The corresponding $\overline{\text{QERR}}$ output signal for the data inputs is generated two clock cycles after the data, to which the $\overline{\text{QERR}}$ signal applies, is registered. The IDT74SSTUBF32868A accepts a parity bit from the memory controller on the parity bit (PAR_IN) input, compares it with the data received on the DIMM-independent D-inputs (D1-D5, D7, D9-D12, D17-D28 when C = 0; or D1-D12, D17-D20, D22, D24-D28 when C = 1) and indicates whether a parity error has

occurred on the open-drain $\overline{\text{QERR}}$ pin (active low). The convention is even parity, i.e., valid parity is defined as an even number of ones across the DIMM-independent data inputs combined with the parity input bit. To calculate parity, all DIMM-independent D-inputs must be tied to a known logic state. If an error occurs and the $\overline{\text{QERR}}$ output is driven low, it stays latched low for a minimum of two clock cycles or until $\overline{\text{RESET}}$ is driven low. If two or more consecutive parity errors occur, the $\overline{\text{QERR}}$ output is driven low and latched low for a clock duration equal to the parity error duration or until $\overline{\text{RESET}}$ is driven low. If a parity error occurs on the clock cycle before the device enters the low-power (LPM) and the $\overline{\text{QERR}}$ output is driven low, then it stays latched low for the LPM duration plus two clock cycles or until $\overline{\text{RESET}}$ is driven low. The DIMM-dependent signals (DCKE0, DCKE1, DODT0, DODT1, $\overline{\text{DCS0}}$ and $\overline{\text{DCS1}}$) are not included in the parity check computation.

The C input controls the pinout configuration from register-A configuration (when low) to register-B configuration (when high). The C input should not be switched during normal operation. It should be hardwired to a valid low or high level to configure the register in the desired mode. The device also supports low-power active operation by monitoring both system chip select ($\overline{\text{DCS0}}$ and $\overline{\text{DCS1}}$) and CSGEN inputs and will gate the Qn outputs from changing states when CSGEN, $\overline{\text{DCS0}}$, and $\overline{\text{DCS1}}$ inputs are high. If CSGEN, $\overline{\text{DCS0}}$ or $\overline{\text{DCS1}}$ input is low, the Qn outputs will function normally. Also, if both $\overline{\text{DCS0}}$ and $\overline{\text{DCS1}}$ inputs are high, the device will gate the $\overline{\text{QERR}}$ output from changing states. If either $\overline{\text{DCS0}}$ or $\overline{\text{DCS1}}$ is low, the $\overline{\text{QERR}}$ output will function normally. The $\overline{\text{RESET}}$ input has priority over the $\overline{\text{DCS0}}$ and $\overline{\text{DCS1}}$ control and when driven low will force the Qn outputs low, and the $\overline{\text{QERR}}$ output high. If the chip-select control functionality is not desired, then the CSGEN input can be hard-wired to ground, in which case, the setup-time requirement for $\overline{\text{DCS0}}$ and $\overline{\text{DCS1}}$ would be the same as for the other D data inputs. To control the low-power mode with $\overline{\text{DCS0}}$ and $\overline{\text{DCS1}}$ only, then the CSGEN input should be pulled up to VDD through a pullup resistor. The two VREF pins (A1 and V1) are connected together internally by approximately 150. However, it is necessary to connect only one of the two VREF pins to the external VREF power supply. An unused VREF pin should be terminated with a VREF coupling capacitor.

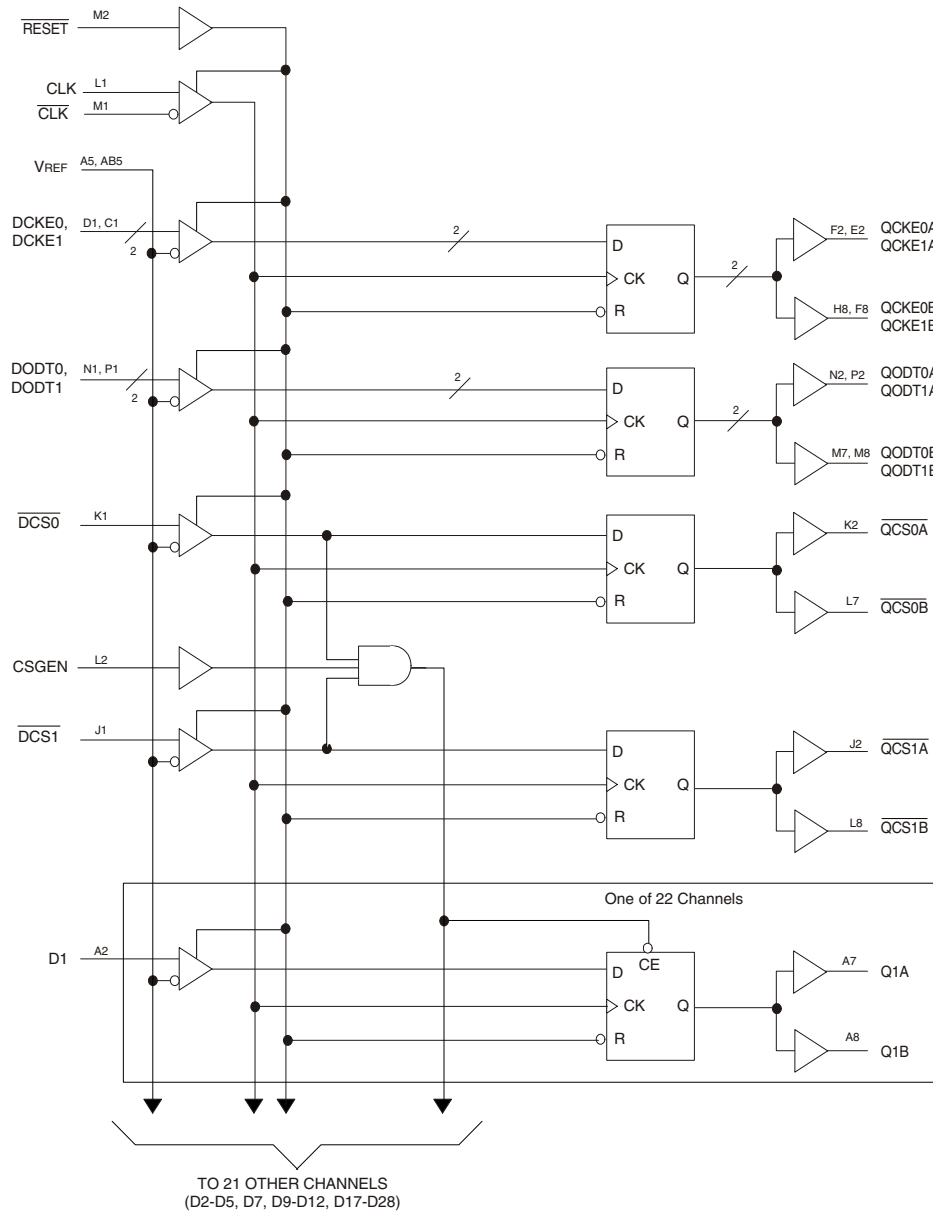
Features

- 28-bit 1:2 registered buffer with parity check functionality
- Supports SSTL_18 JEDEC specification on data inputs and outputs
- Supports LVCMOS switching levels on CSGEN and RESET inputs
- Low voltage operation: VDD = 1.7V to 1.9V
- Available in 176-ball LFBGA package

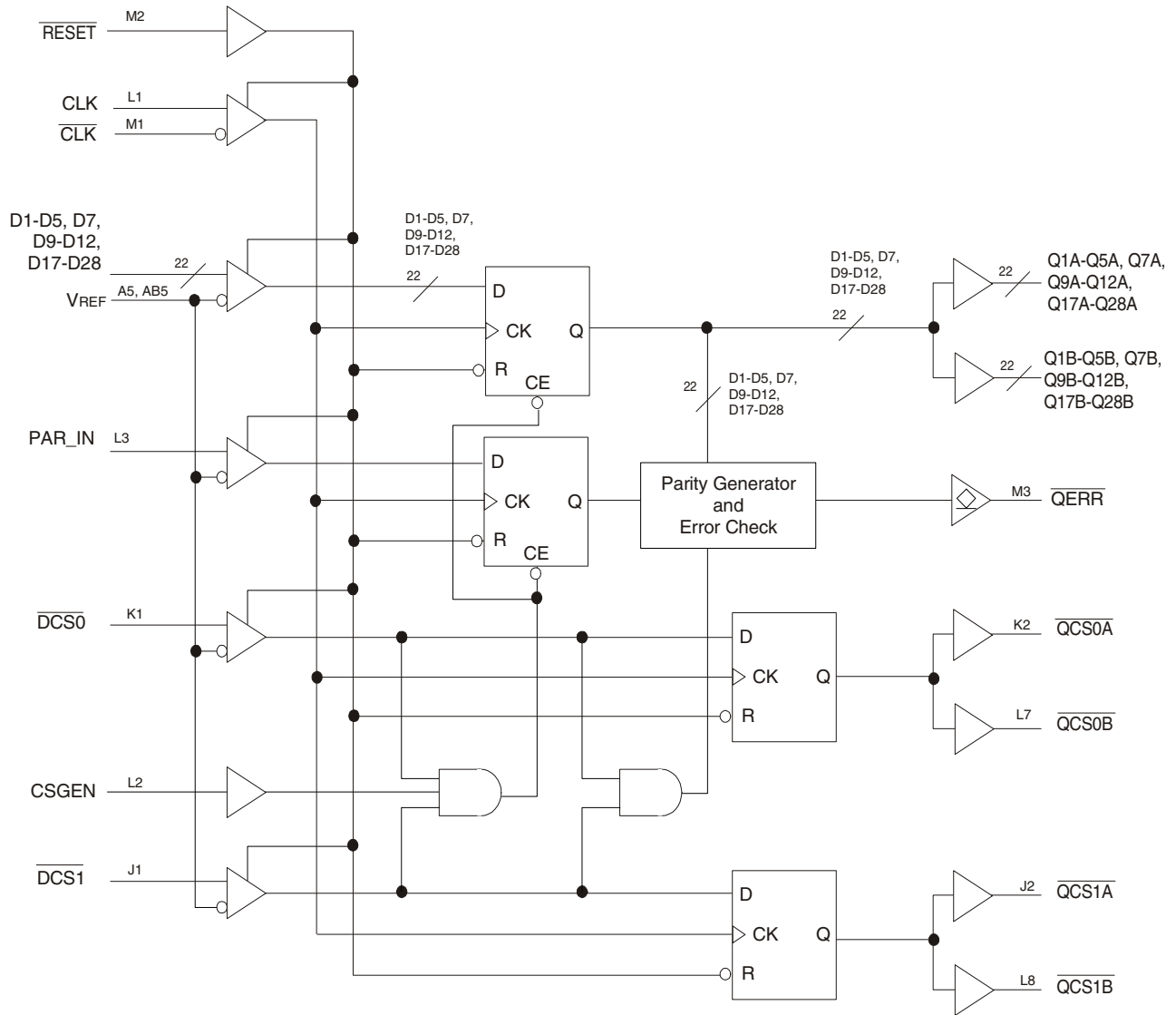
Applications

- DDR2 Memory Modules
- Provides complete DDR DIMM solution with ICS98ULPA877A or IDTCSPUA877A
- Ideal for DDR2 667 and 800

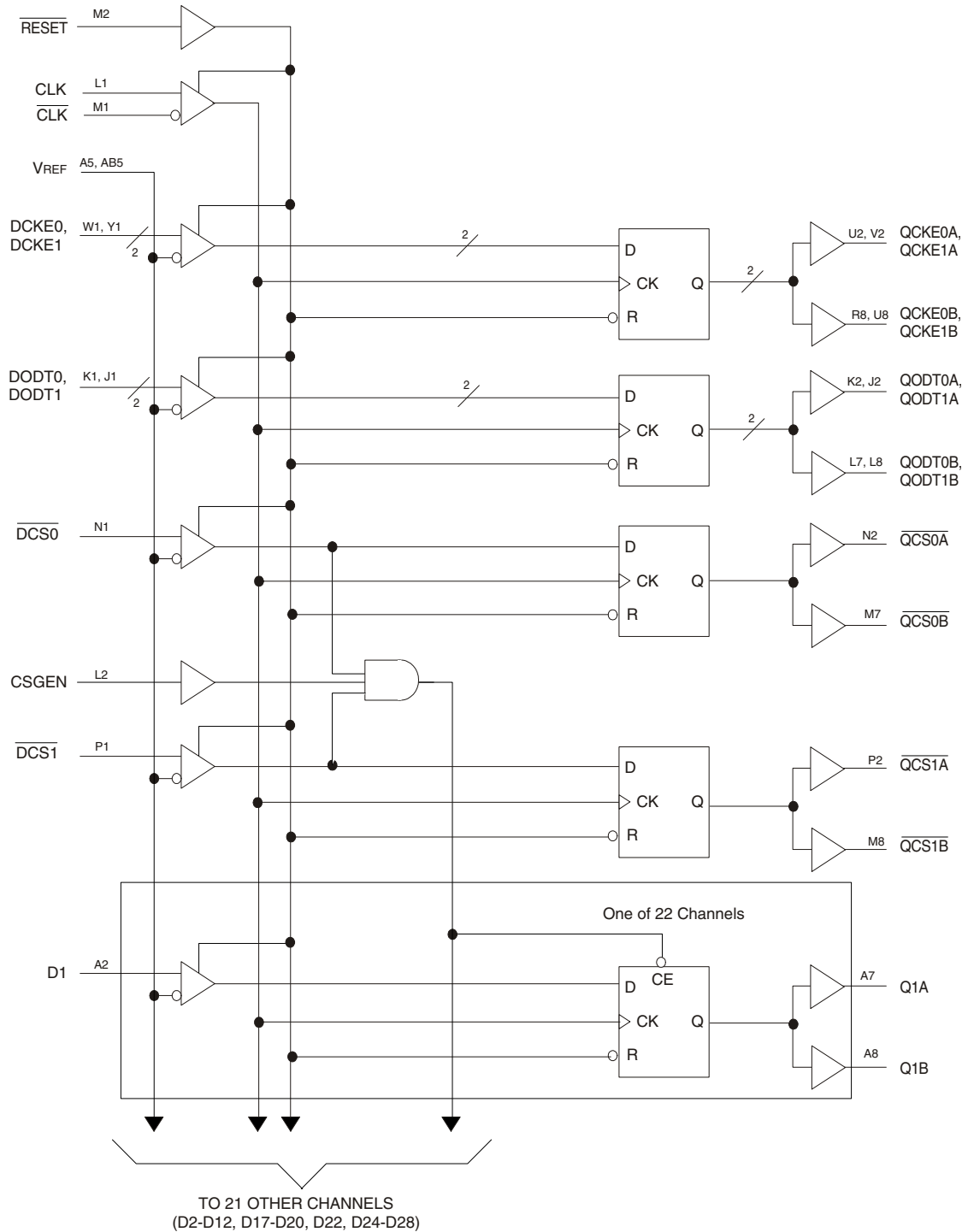
Block Diagram



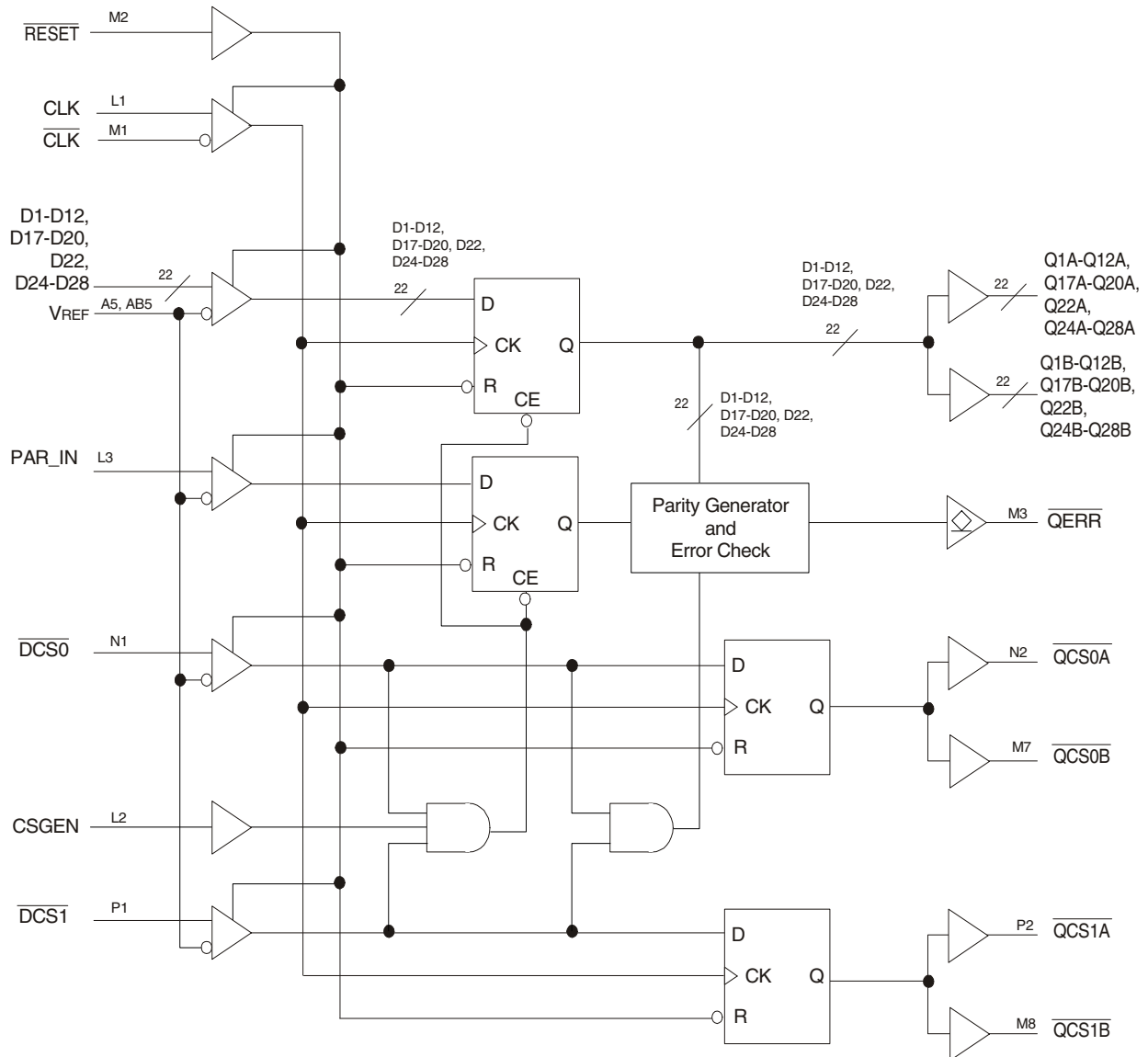
Parity Logic Diagram



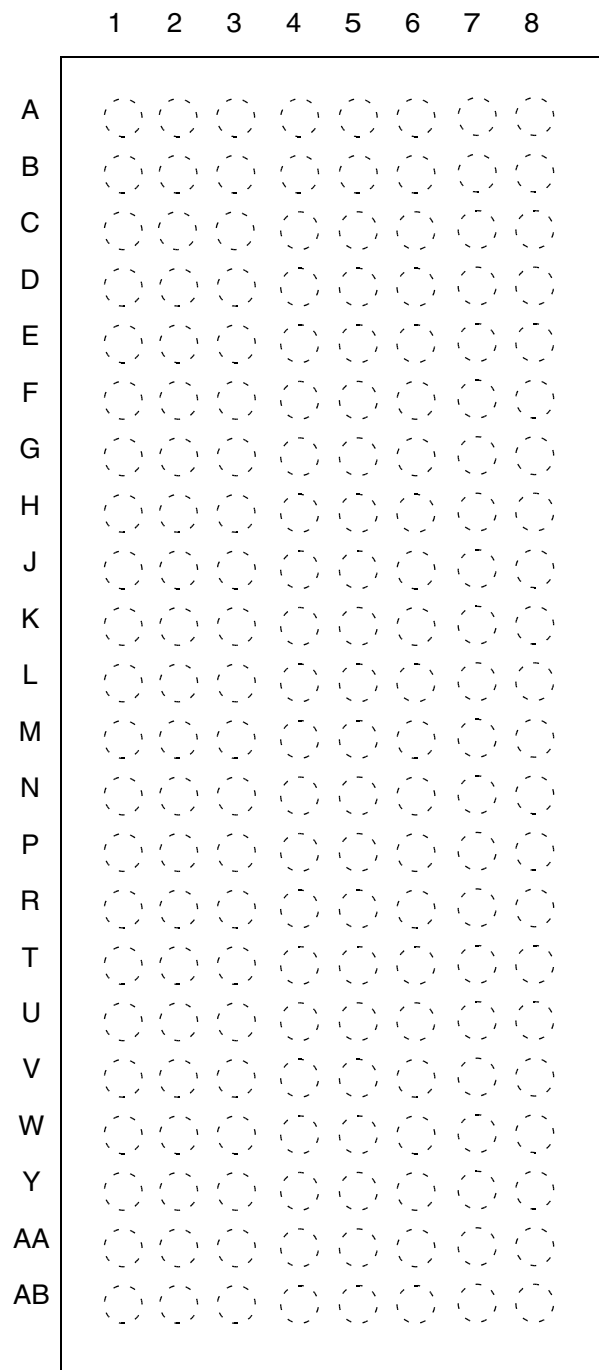
Block Diagram



Parity Logic Diagram



Pin Configuration



**176 BALL BGA
TOP VIEW**

Pin Configuration

| | | | | | | | | |
|----|--------------------------|---------------------------|--------------------------|-----|------|-----|------------------|------------------|
| A | D2 | D1 | C | GND | VREF | GND | Q1A | Q1B |
| B | D4 | D3 | VDD | VDD | VDD | VDD | Q2A | Q2B |
| C | D6 (DCKE1) | D5 | GND | GND | GND | GND | Q3A | Q3B |
| D | D8 (DCKE0) | D7 | VDD | VDD | VDD | VDD | Q4A | Q4B |
| E | D9 | Q6A (QCKE1A) | GND | GND | GND | GND | Q5A | Q5B |
| F | D10 | Q8A (QCKE0A) | VDD | VDD | VDD | VDD | Q7A | Q6B (QCKE1B) |
| G | D11 | Q10A | GND | GND | GND | GND | Q9A | Q7B |
| H | D12 | Q12A | VDD | VDD | VDD | VDD | Q11A | Q8B (QCKE0B) |
| J | $\overline{\text{DCS1}}$ | $\overline{\text{QCS1}}$ | GND | GND | GND | GND | Q10B | Q9B |
| K | $\overline{\text{DCS0}}$ | $\overline{\text{QCS0}}$ | VDD | VDD | VDD | VDD | Q12B | Q11B |
| L | CLK | CSGEN | PAR_IN | GND | GND | GND | Q14B (QCS0B) | Q13B (QCS1B) |
| M | $\overline{\text{CLK}}$ | $\overline{\text{RESET}}$ | $\overline{\text{QERR}}$ | VDD | VDD | VDD | Q15B (QODT0B) | Q16B (QODT1B) |
| N | D15 (DODT0) | Q15A (QODT0A) | GND | GND | GND | GND | Q17B | Q18B |
| P | D16 (DODT1) | Q16A (QODT1A) | VDD | VDD | VDD | VDD | Q19B | Q20B |
| R | D17 | Q17A | GND | GND | GND | GND | Q18A | Q21B |
| T | D18 | Q19A | VDD | VDD | VDD | VDD | Q20A | Q22B |
| U | D19 | Q21A | GND | GND | GND | GND | Q22A | Q23B |
| V | D20 | Q23A | VDD | VDD | VDD | VDD | Q24A | Q24B |
| W | D21 | D22 | GND | GND | GND | GND | Q25A | Q25B |
| Y | D23 | D24 | VDD | VDD | VDD | VDD | Q26A | Q26B |
| AA | D25 | D26 | GND | GND | GND | GND | Q27A | Q27B |
| AB | D27 | D28 | NC | VDD | VREF | VDD | Q28A | Q28B |
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 |

| | | | | | | | | |
|----|-------------------------|---------------------------|--------------------------|-----|------|-----|------------------|------------------|
| A | D2 | D1 | C | GND | VREF | GND | Q1A | Q1B |
| B | D4 | D3 | VDD | VDD | VDD | VDD | Q2A | Q2B |
| C | D6 | D5 | GND | GND | GND | GND | Q3A | Q3B |
| D | D8 | D7 | VDD | VDD | VDD | VDD | Q4A | Q4B |
| E | D9 | Q6A | GND | GND | GND | GND | Q5A | Q5B |
| F | D10 | Q8A | VDD | VDD | VDD | VDD | Q7A | Q6B |
| G | D11 | Q10A | GND | GND | GND | GND | Q9A | Q7B |
| H | D12 | Q12A | VDD | VDD | VDD | VDD | Q11A | Q8B |
| J | D13 (DODT1) | Q13A (QODT1A) | GND | GND | GND | GND | Q10B | Q9B |
| K | D14 (DODT0) | Q14A (QODT0A) | VDD | VDD | VDD | VDD | Q12B | Q11B |
| L | CLK | CSGEN | PAR_IN | GND | GND | GND | Q14B (QODT0B) | Q13B (QODT1B) |
| M | $\overline{\text{CLK}}$ | $\overline{\text{RESET}}$ | $\overline{\text{QERR}}$ | VDD | VDD | VDD | Q15B (QCS0B) | Q16B (QCS1B) |
| N | D15 (DCS0) | Q15A (QCS0A) | GND | GND | GND | GND | Q17B | Q18B |
| P | D16 (DCS1) | Q16A (QCS1A) | VDD | VDD | VDD | VDD | Q19B | Q20B |
| R | D17 | Q17A | GND | GND | GND | GND | Q18A | Q21B (QCKE0B) |
| T | D18 | Q19A | VDD | VDD | VDD | VDD | Q20A | Q22B |
| U | D19 | Q21A (QCKE0A) | GND | GND | GND | GND | Q22A | Q23B (QCKE1B) |
| V | D20 | Q23A (QCKE1A) | VDD | VDD | VDD | VDD | Q24A | Q24B |
| W | D21 (DCKE0) | D22 | GND | GND | GND | GND | Q25A | Q25B |
| Y | D23 (DCKE1) | D24 | VDD | VDD | VDD | VDD | Q26A | Q26B |
| AA | D25 | D26 | GND | GND | GND | GND | Q27A | Q27B |
| AB | D27 | D28 | NC | VDD | VREF | VDD | Q28A | Q28B |
| | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 |

1:2 REGISTER A (C = 0)

1:2 REGISTER B (C = 1)

NOTE: NC denotes a no-connect (ball present but not connected to the die).

Function Table

| Inputs ¹ | | | | | | | Outputs | | | |
|---------------------------|--------------------------|--------------------------|------------------|------------------|-------------------------|-------------------|-----------------------------|-----------------------------|-----------------------------|-----------------------------|
| $\overline{\text{RESET}}$ | $\overline{\text{DCS0}}$ | $\overline{\text{DCS1}}$ | CSGEN | CLK | $\overline{\text{CLK}}$ | Dx, DODT, DCKE | Qn | $\overline{\text{QCS0}}$ | $\overline{\text{QCS1}}$ | QODT, QCKE |
| H | L | L | X | ↑ | ↓ | L | L | L | L | L |
| H | L | L | X | ↑ | ↓ | H | H | L | L | H |
| H | L | L | X | L or H | L or H | X | Q ₀ ² | Q ₀ ² | Q ₀ ² | Q ₀ ² |
| H | L | H | X | ↑ | ↓ | L | L | L | H | L |
| H | L | H | X | ↑ | ↓ | H | H | L | H | H |
| H | L | H | X | L or H | L or H | X | Q ₀ ² | Q ₀ ² | Q ₀ ² | Q ₀ ² |
| H | H | L | X | ↑ | ↓ | L | L | H | L | L |
| H | H | L | X | ↑ | ↓ | H | H | H | L | H |
| H | H | L | X | L or H | L or H | X | Q ₀ ² | Q ₀ ² | Q ₀ ² | Q ₀ ² |
| H | H | H | L | ↑ | ↓ | L | L | H | H | L |
| H | H | H | L | ↑ | ↓ | H | H | H | H | H |
| H | H | H | L | L or H | L or H | X | Q ₀ ² | Q ₀ ² | Q ₀ ² | Q ₀ ² |
| H | H | H | H | ↑ | ↓ | L | Q ₀ ² | H | H | L |
| H | H | H | H | ↑ | ↓ | H | Q ₀ ² | H | H | H |
| H | H | H | H | L or H | L or H | X | Q ₀ ² | Q ₀ ² | Q ₀ ² | Q ₀ ² |
| L | X or Floating | X or Floating | X or Floating | X or Floating | X or Floating | X or Floating | L | L | L | L |

1 H = HIGH Voltage Level

L = LOW Voltage Level

X = Don't Care

↑ = LOW to HIGH

↓ = HIGH to LOW

2 Output Level before the indicated steady-state conditions were established.

Parity and Standby Function Table

| Inputs ¹ | | | | | | | Outputs |
|---------------------------|--------------------------|--------------------------|---------------|-------------------------|-----------------------------------|---------------------|---|
| $\overline{\text{RESET}}$ | $\overline{\text{DCS0}}$ | $\overline{\text{DCS1}}$ | CLK | $\overline{\text{CLK}}$ | Σ of Inputs = H (D1 - D28) | PAR_IN ² | $\overline{\text{QERR}}$ ³ |
| H | L | X | ↑ | ↓ | Even | L | H |
| H | L | X | ↑ | ↓ | Odd | L | L |
| H | L | X | ↑ | ↓ | Even | H | L |
| H | L | X | ↑ | ↓ | Odd | H | H |
| H | X | L | ↑ | ↓ | Even | L | H |
| H | X | L | ↑ | ↓ | Odd | L | L |
| H | X | L | ↑ | ↓ | Even | H | L |
| H | X | L | ↑ | ↓ | Odd | H | H |
| H | H | H | ↑ | ↓ | X | X | $\overline{\text{QERR}}_0$ ⁴ |
| H | X | X | ↑ | ↓ | X | X | $\overline{\text{QERR}}_0$ |
| L | X or Floating | X or Floating | X or Floating | X or Floating | X or Floating | X or Floating | H |

1 H = HIGH Voltage Level

L = LOW Voltage Level

X = Don't Care

↑ = LOW to HIGH

↓ = HIGH to LOW

2 PAR_IN arrives one clock cycle after the data to which it applies.

3 This transition assumes $\overline{\text{QERR}}$ is HIGH at the crossing of CLK going HIGH and $\overline{\text{CLK}}$ going LOW. If $\overline{\text{QERR}}$ is LOW, it stays latched LOW for two clock cycles or until $\overline{\text{RESET}}$ is driven LOW.

4 If $\overline{\text{DCS0}}$, $\overline{\text{DCS1}}$, and CSGEN are driven HIGH, the device is placed in low-power mode (LPM). If a parity error occurs on the clock cycle before the device enters the LPM and the $\overline{\text{QERR}}$ output is driven LOW, it stays latched LOW for the LPM plus two clock cycles or until $\overline{\text{RESET}}$ is driven LOW.

Absolute Maximum Ratings

Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

| Item | | Rating |
|---|--------------|----------------------|
| Supply Voltage, VDD | | -0.5V to 2.5V |
| Input Voltage Range, Vi ¹ | | -0.5V to VDD + 2.5V |
| Output Voltage Range, Vo ^{1,2} | | -0.5V to VDDQ + 0.5V |
| Input Clamp Current, I _{IK} | | ±50mA |
| Output Clamp Current, I _{OK} | | ±50mA |
| Continuous Output Clamp Current, I _O | | ±50mA |
| Continuous Current through each VDD or GND | | ±100mA |
| Package Thermal Impedance (θ _{ja}) ³ | 0m/s Airflow | 40.4° C/W |
| | 1m/s Airflow | 29.1° C/W |
| Storage Temperature, T _{STG} | | -65 to +150° C |

1 The input and output negative voltage ratings may be exceeded if the ratings of the I/P and O/P clamp current are observed.

2 This current will flow only when the output is in the high state level $V_O > V_{DDQ}$.

3 The package thermal impedance is calculated in accordance with JESD 51.

Output Buffer Characteristics

Output edge rates over recommended operating free-air temperature range

| Parameter | VDD = 1.8V ± 0.1V | | Units |
|---------------------------------|-------------------|------|-------|
| | Min. | Max. | |
| dV/dt _r | 1 | 4 | V/ns |
| dV/dt _f | 1 | 4 | V/ns |
| dV/dt _Δ ¹ | | 1 | V/ns |

1 Difference between dV/dt_r (rising edge rate) and dV/dt_f (falling edge rate).

Terminal Functions

| Terminal Name | Electrical Characteristics | Description |
|---|----------------------------|--|
| GND | Ground Input | Ground |
| V _{DD} | 1.8V nominal | Power Supply Voltage |
| V _{REV} | 0.9V nominal | Input Reference Clock |
| CLK | Differential Input | Positive Master Clock Input |
| $\overline{\text{CLK}}$ | Differential Input | Negative Master Clock Input |
| C | LVC MOS Input | Configuration Control Inputs - Register A or Register B |
| $\overline{\text{RESET}}$ | LVC MOS Input | Asynchronous Reset Input. Resets registers and disables V _{ref} data and clock differential-input receivers. |
| CSGEN | LVC MOS Input | Chip select gate enable – When high, D1-D28 inputs will be latched only when at least one chip select input is low during the rising edge of the clock. When low, the D1-D28 inputs will be latched and redriven on every rising edge of the clock. |
| D1 - D28 | SSTL_18 Input | Data Input. Clocked in on the crossing of the rising edge of CLK and the falling edge of CLK. |
| $\overline{\text{DCS0}}$, $\overline{\text{DCS1}}$ | SSTL_18 Input | Chip select inputs – These pins initiate DRAM address/command decodes, and as such at least one will be low when a valid address/command is present. The Register can be programmed to redrive all D inputs (CSGEN high) only when at least one chip select input is low. If CSGEN, $\overline{\text{DCS0}}$, and $\overline{\text{DCS1}}$ inputs are high, D1-D28 inputs will be disabled. |
| DCKE0, DCKE1 | SSTL_18 Input | The outputs of this register bit will not be suspended by the $\overline{\text{DCS0}}$ and $\overline{\text{DCS1}}$ controls |
| DODT0, DODT1 | SSTL_18 Input | The outputs of this register bit will not be suspended by the $\overline{\text{DCS0}}$ and $\overline{\text{DCS1}}$ controls |
| PAR_IN | SSTL_18 Input | Parity Input arrives one cycle after corresponding data input |
| Q1 - Q28 | 1.8V CMOS | Data Outputs that are suspended by the $\overline{\text{DCS0}}$ and $\overline{\text{DCS1}}$ controls |
| $\overline{\text{QCS0}}$, $\overline{\text{QCS1}}$ | 1.8V CMOS | Data Output that will not be suspended by the $\overline{\text{DCS0}}$ and $\overline{\text{DCS1}}$ controls |
| QCKE0, QCKE1 | 1.8V CMOS | Data Output that will not be suspended by the $\overline{\text{DCS0}}$ and $\overline{\text{DCS1}}$ controls |
| QODT0, QODT1 | 1.8V CMOS | Data Output that will not be suspended by the $\overline{\text{DCS0}}$ and $\overline{\text{DCS1}}$ controls |
| $\overline{\text{QERR}}$ | Open Drain Output | Output Error bit, generated one cycle after the corresponding data output |
| NC | | No Connection |

Operating Characteristics, $T_A = 25^\circ\text{C}$

The $\overline{\text{RESET}}$ and Cn inputs of the device must be held at valid levels (not floating) to ensure proper device operation. The differential inputs must not be floating unless $\overline{\text{RESET}}$ is Low.

| Symbol | Parameter | | Min. | Typ. | Max. | Units |
|--------|--------------------------------|---|-------------------|----------------|-------------------|------------------|
| VDD | I/O Supply Voltage | | 1.7 | 1.8 | 1.9 | V |
| VREF | Reference Voltage | | $0.49 * V_{DD}$ | $0.5 * V_{DD}$ | $0.51 * V_{DD}$ | V |
| VTT | Termination Voltage | | $V_{REF} - 0.04$ | VREF | $V_{REF} + 0.04$ | V |
| Vi | Input Voltage | | 0 | | VDD | V |
| VIH | AC High-Level Input Voltage | Data $\overline{\text{CSR}}$ and PAR_IN inputs | $V_{REF} + 0.25$ | | | V |
| VIL | AC Low-Level Input Voltage | | | | $V_{REF} - 0.25$ | |
| VIH | DC High-Level Input Voltage | | $V_{REF} + 0.125$ | | | |
| VIL | DC Low-Level Input Voltage | | | | $V_{REF} - 0.125$ | |
| VIH | High-Level Input Voltage | $\overline{\text{RESET}}$, C0, C1 | $0.65 * V_{DDQ}$ | | | V |
| VIL | Low-Level Input Voltage | | | | $0.35 * V_{DDQ}$ | |
| VICR | Common Mode Input Range | CLK, $\overline{\text{CLK}}$ | 0.675 | | 1.125 | V |
| VID | Differential Input Voltage | | 600 | | | mV |
| IOH | High-Level Output Current | | | | -6 | mA |
| IOL | Low-Level Output Current | | | | 6 | |
| TA | Operating Free-Air Temperature | | 0 | | +70 | $^\circ\text{C}$ |

DC Electrical Characteristics Over Operating Range

Following Conditions Apply Unless Otherwise Specified:

Operating Condition: $T_A = 0^{\circ}\text{C}$ to $+70^{\circ}\text{C}$, $V_{DDQ}/V_{DD} = 2.5\text{V} \pm 0.2\text{V}$.

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|-----------|--|---|------|------|------|--|
| V_{OH} | Output HIGH Voltage | $I_{OH} = -6\text{mA}$, $V_{DDQ} = 1.7\text{V}$ | 1.2 | | | V |
| V_{OL} | Output LOW Voltage | $I_{OL} = 6\text{mA}$, $V_{DDQ} = 1.7\text{V}$ | | | 0.5 | V |
| I_{IL} | All Inputs | $V_I = V_{DD}$ or GND; $V_{DD} = 1.9\text{V}$ | -5 | | +5 | μA |
| I_{DD} | Static Standby | $I_O = 0$, $V_{DD} = 1.9\text{V}$, $\overline{\text{RESET}} = \text{GND}$ | | | 200 | μA |
| | Static Operating | $I_O = 0$, $V_{DD} = 1.9\text{V}$, $\overline{\text{RESET}} = V_{DD}$, $V_I = V_{IH(AC)}$ or $V_{IL(AC)}$, $\text{CLK} = \overline{\text{CLK}} = V_{IH(AC)}$ or $V_{IL(AC)}$ | | | 10 | mA |
| | | $I_O = 0$, $V_{DD} = 1.9\text{V}$, $\overline{\text{RESET}} = V_{DD}$, $V_I = V_{IH(AC)}$ or $V_{IL(AC)}$, $\text{CLK} = V_{IH(AC)}$, $\overline{\text{CLK}} = V_{IL(AC)}$ | | 180 | | |
| I_{DDD} | Dynamic Operating (clock only) | $I_O = 0$, $V_{DD} = 1.8\text{V}$, $\overline{\text{RESET}} = V_{DD}$, $V_I = V_{IH(AC)}$ or $V_{IL(AC)}$, CLK and $\overline{\text{CLK}}$ switching 50% duty cycle | | 500 | | $\mu\text{A}/\text{Clock MHz}$ |
| | Dynamic Operating (per each data input) 1:2 mode | $I_O = 0$, $V_{DD} = 1.8\text{V}$, $\overline{\text{RESET}} = V_{DD}$, $V_I = V_{IH(AC)}$ or $V_{IL(AC)}$, CLK and $\overline{\text{CLK}}$ switching 50% duty cycle. One data input switching at half clock frequency, 50% duty cycle. | | 44 | | $\mu\text{A}/\text{Clock MHz}/\text{Data}$ |
| C_i | Data Inputs | $V_I = V_{REF} \pm 250\text{mV}$ | 2 | | 3.5 | pF |
| | CLK and $\overline{\text{CLK}}$ | $V_{ICR} = 0.9\text{V}$, $V_{IPP} = 600\text{mV}$ | 2.5 | | 4 | |
| | $\overline{\text{RESET}}$ | $V_I = V_{DD}$ or GND | | 5 | | |

Timing Requirements Over Recommended Operating Free-Air Temperature Range

| Symbol | Parameter | VDD = 1.8V ± 0.1V | | Units | |
|-----------------------------------|--------------------------------------|--|------|-------|----|
| | | Min. | Max. | | |
| f _{CLOCK} | Clock Frequency | | 410 | MHz | |
| t _w | Pulse Duration, CLK, CLK HIGH or LOW | 1 | | ns | |
| t _{ACT} ^{1,2} | Differential Inputs Active Time | | 10 | ns | |
| t _{INACT} ^{1,3} | Differential Inputs Inactive Time | | 15 | ns | |
| t _{SU} | Setup Time | $\overline{DCS0}$ before CLK \uparrow , $\overline{CLK}\downarrow$, $\overline{DCS1}$ and CSGEN HIGH; $\overline{DCS1}$ before CLK \uparrow , $\overline{CLK}\downarrow$, $\overline{DCS0}$ and CSGEN HIGH; | 0.6 | | ns |
| | | $\overline{DCS0}$ before CLK \uparrow , $\overline{CLK}\downarrow$, $\overline{DCS1}$ LOW and CSGEN HIGH or LOW; $\overline{DCS1}$ before CLK \uparrow , $\overline{CLK}\downarrow$, $\overline{DCS0}$ LOW and CSGEN HIGH or LOW | 0.5 | | ns |
| | | DODT _n , DCKEn, PAR_IN, and data before CLK \uparrow , $\overline{CLK}\downarrow$ | 0.5 | | ns |
| t _H | Hold Time | \overline{DCSn} , DODT _n , DCKEn, and data after CLK \uparrow , $\overline{CLK}\downarrow$ | 0.4 | | ns |
| | | PAR_IN after CLK \uparrow , $\overline{CLK}\downarrow$ | 0.4 | | ns |

1 This parameter is not production tested.

2 VREF must be held at a valid input voltage level and data inputs must be held at valid voltage levels for a minimum time of t_{ACT} (max) after \overline{RESET} is taken HIGH.

3 VREF data and clock inputs must be held at valid input voltage levels (not floating) for a minimum time of t_{INACT} (max) after \overline{RESET} is taken LOW.

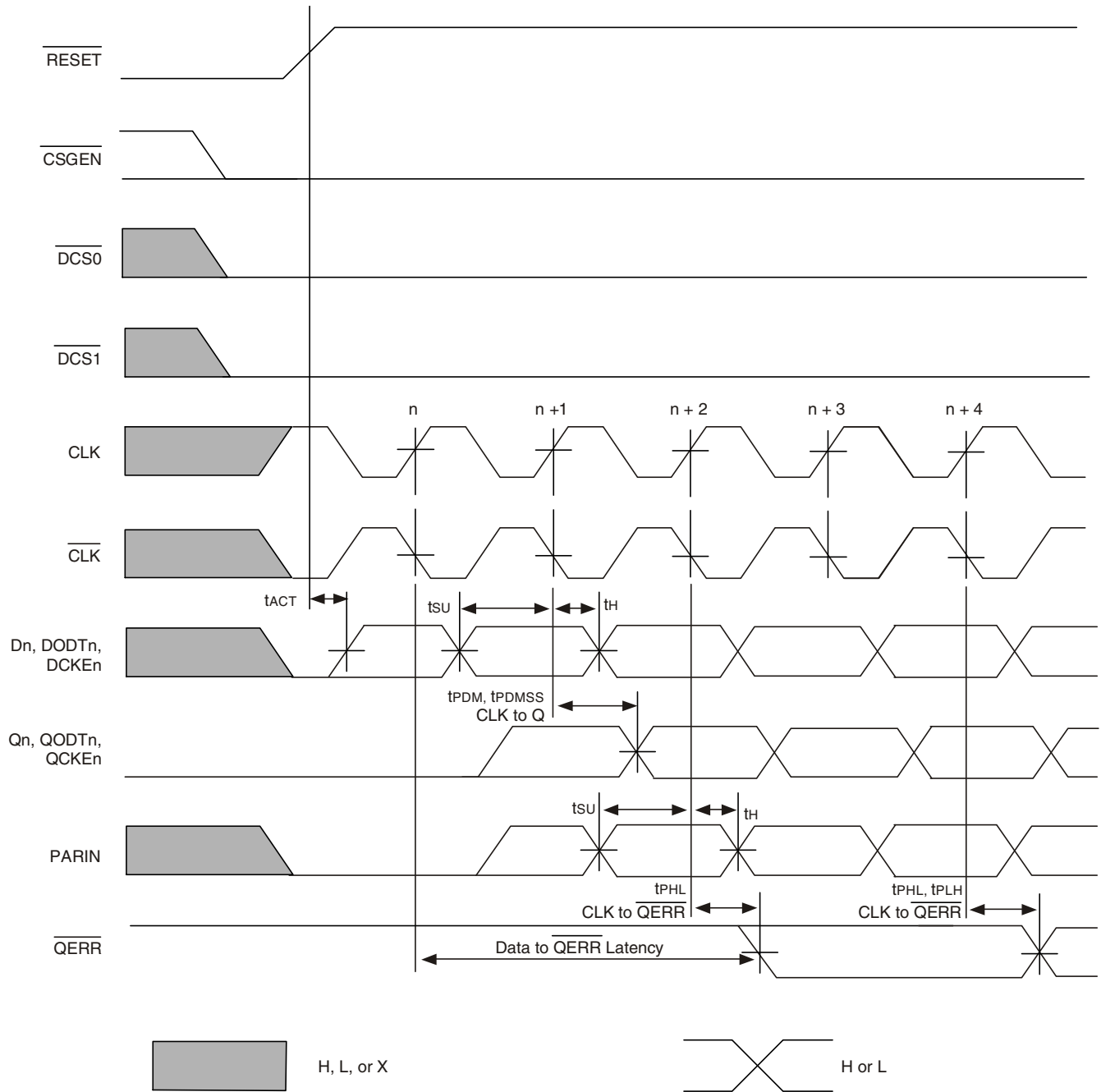
Switching Characteristics Over Recommended Free Air Operating Range (unless otherwise noted)

| Symbol | Parameter | VDD = 1.8V ± 0.1V | | Units |
|-------------------------------|--|-------------------|------|-------|
| | | Min. | Max. | |
| f _{MAX} | Max Input Clock Frequency | 410 | | MHz |
| t _{PDM} ¹ | Propagation Delay, single bit switching, CLK \uparrow / $\overline{CLK}\downarrow$ to Q _n | 1.1 | 1.5 | ns |
| t _{PDQ} ² | Propagation Delay, single-bit switching, CLK \uparrow / $\overline{CLK}\downarrow$ to Q _n | 0.4 | 1 | ns |
| t _{PDMS} | Propagation Delay, simultaneous switching, CLK \uparrow / $\overline{CLK}\downarrow$ to Q _n | | 1.6 | ns |
| t _{LH} | LOW to HIGH Propagation Delay, CLK \uparrow / $\overline{CLK}\downarrow$ to \overline{QERR} | 1.2 | 3 | ns |
| t _{HL} | HIGH to LOW Propagation Delay, CLK \uparrow / $\overline{CLK}\downarrow$ to \overline{QERR} | 0.7 | 2.4 | ns |
| t _{PLH} | HIGH to LOW Propagation Delay, $\overline{RESET}\downarrow$ to Q _n \downarrow | | 3 | ns |
| t _{PHL} | LOW to HIGH Propagation Delay, $\overline{RESET}\downarrow$ to $\overline{QERR}\uparrow$ | | 3 | ns |

1 Design target as per JEDEC specifications.

2 Production Test. (See Product Test Circuit in TEST CIRCUIT AND WAVEFORM section.)

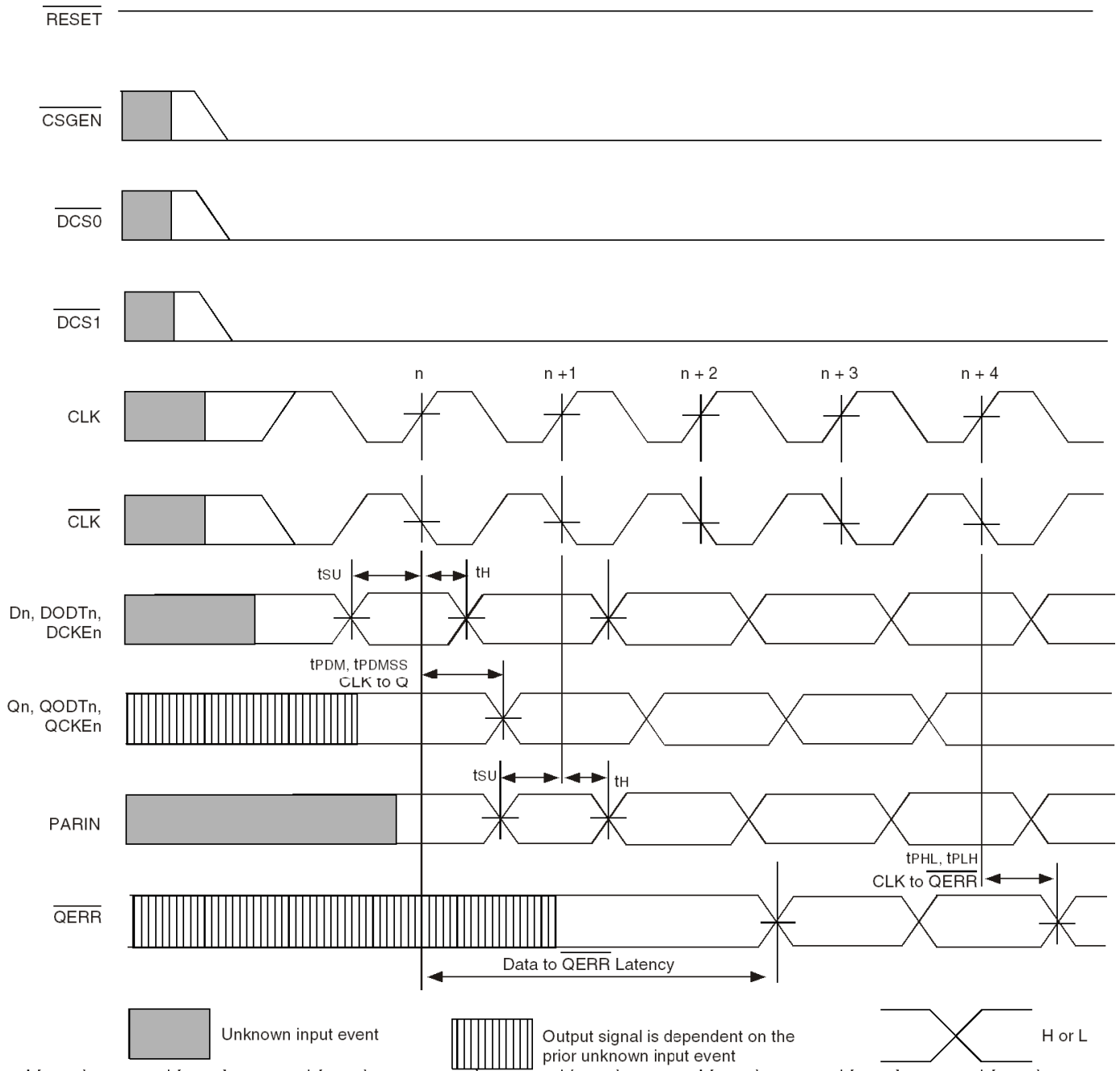
Register Timing



NOTES:

1. After $\overline{\text{RESET}}$ is switched from LOW to HIGH, all data and PAR_IN inputs signals must be set and held LOW for a minimum time of t_{ACTMAX} , to avoid false error.
2. If the data is clocked in on the n clock pulse, the $\overline{\text{QERR}}$ output signal will be generated on the n+2 clock pulse, and it will be valid on the n+3 clock pulse.

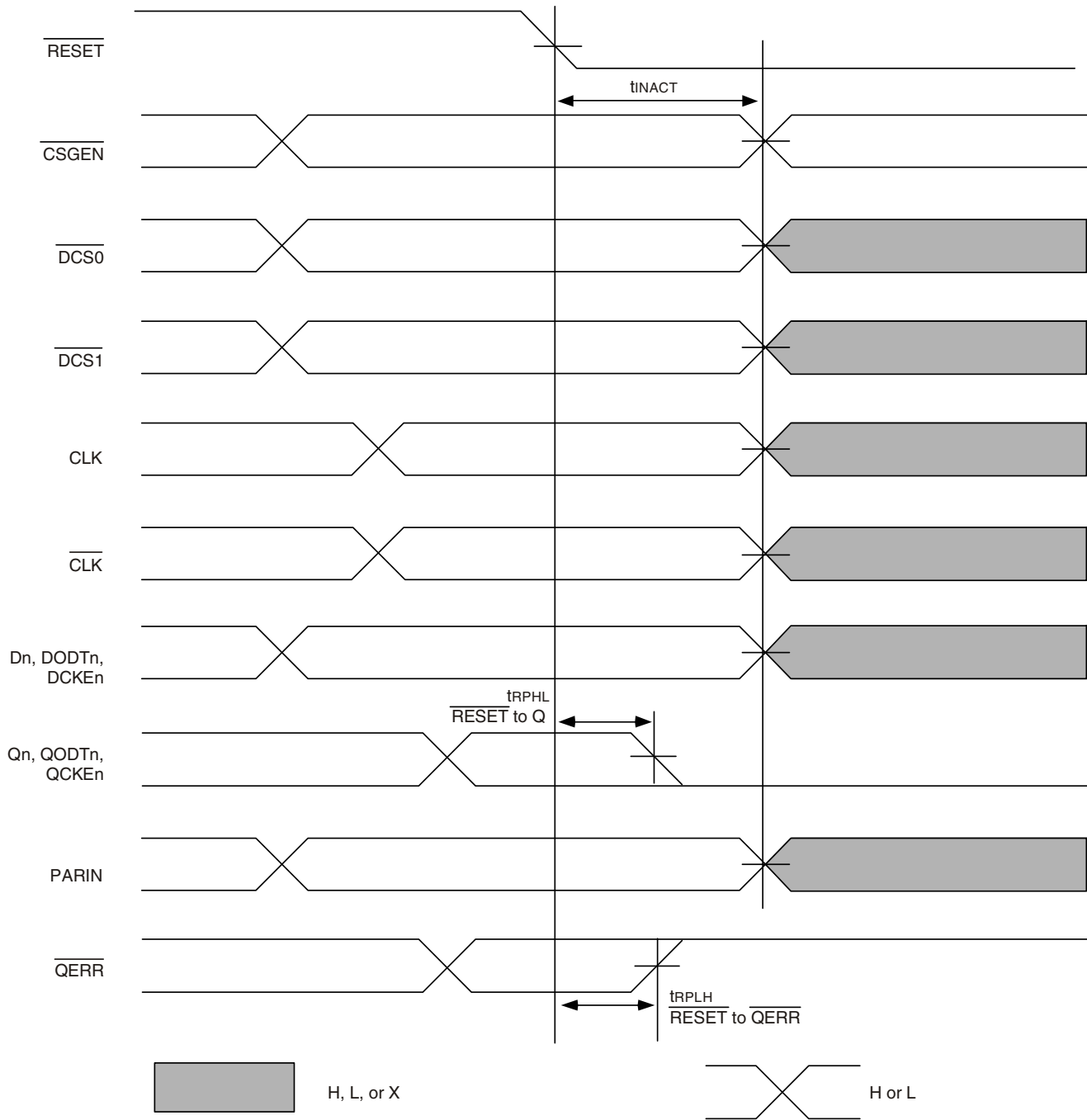
Register Timing



NOTE:

1. If the data is clocked in on the n clock pulse, the \overline{QERR} output signal will be generated on the $n+2$ clock pulse, and it will be valid on the $n+3$ clock pulse. If an error occurs and the \overline{QERR} output is driven LOW, it stays latched LOW for a minimum of two clock cycles or until \overline{RESET} is driven LOW.

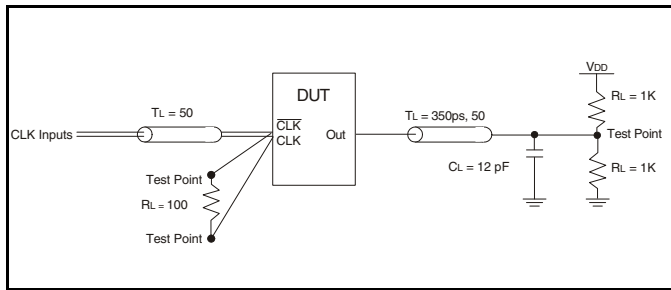
Register Timing



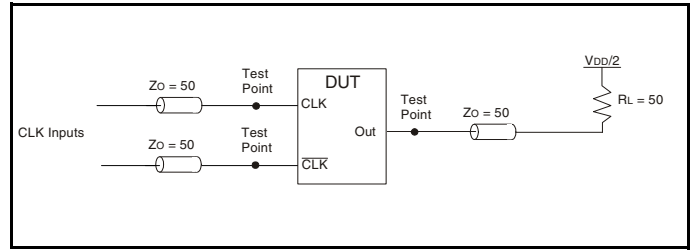
NOTE:

1. After **RESET** is switched from LOW to HIGH, all data and clock inputs signals must be set and held at valid logic levels (not floating) for a minimum time of $t_{INACTMAX}$.

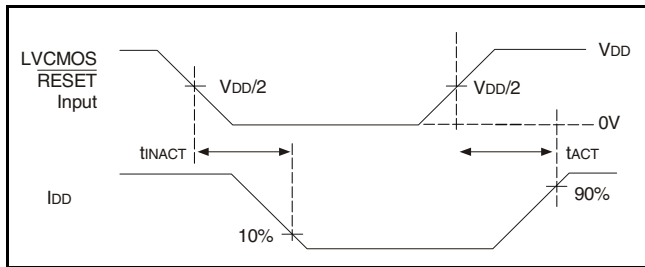
Test Circuits and Waveforms ($V_{DD} = 1.8V \pm 0.1V$)



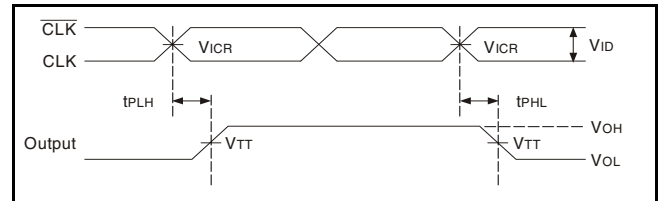
Simulation Load Circuit



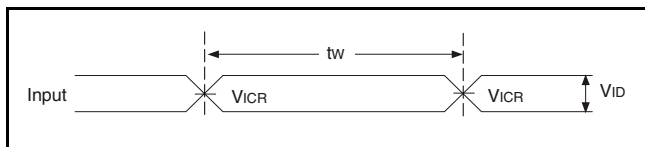
Production-Test Load Circuit



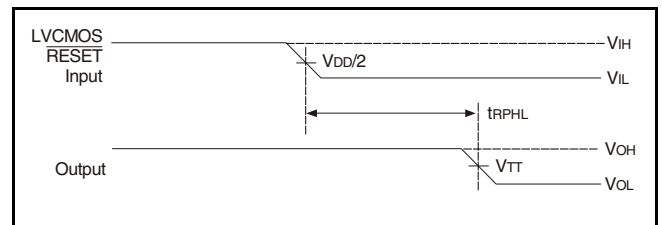
Voltage and Current Waveforms Inputs Active and Inactive Times



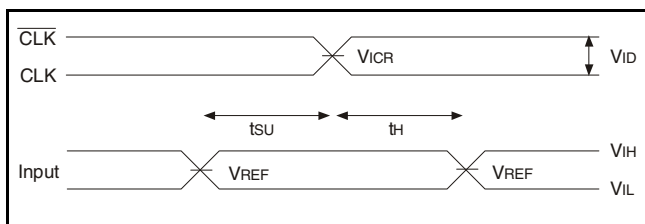
Voltage Waveforms - Propagation Delay Times



Voltage Waveforms - Pulse Duration



Voltage Waveforms - Propagation Delay Times

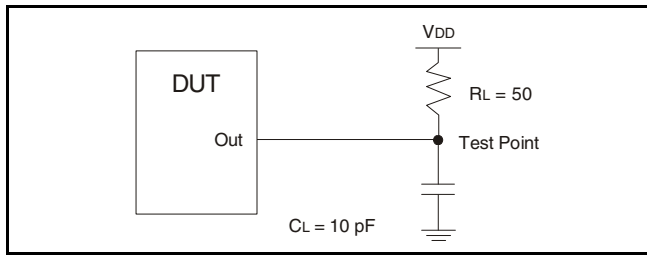


Voltage Waveforms - Setup and Hold Times

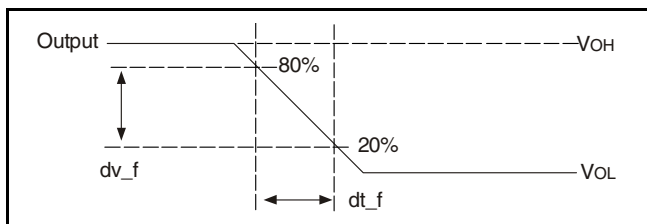
NOTES:

1. CL includes probe and jig capacitance.
2. IDD tested with clock and data inputs held at VDD or GND, and $I_o = 0mA$
3. All input pulses are supplied by generators having the following characteristics: PRR $\leq 10MHz$, $Z_o = 50\Omega$, input slew rate = $1 V/ns \pm 20%$ (unless otherwise specified).
4. The outputs are measured one at a time with one transition per measurement.
5. $V_{TT} = V_{REF} = V_{DD}/2$
6. $V_{IH} = V_{REF} + 250mV$ (AC voltage levels) for differential inputs. $V_{IH} = V_{DD}$ for LVC MOS input.
7. $V_{IL} = V_{REF} - 250mV$ (AC voltage levels) for differential inputs. $V_{IL} = GND$ for LVC MOS input.
8. $V_{ID} = 600mV$.
9. tPLH and tPHL are the same as tPDM.

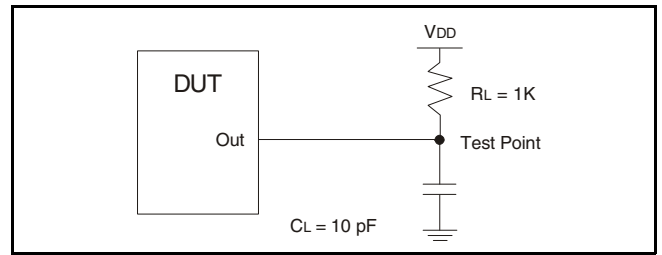
Test Circuits and Waveforms ($V_{DD} = 1.8V \pm 0.1V$)



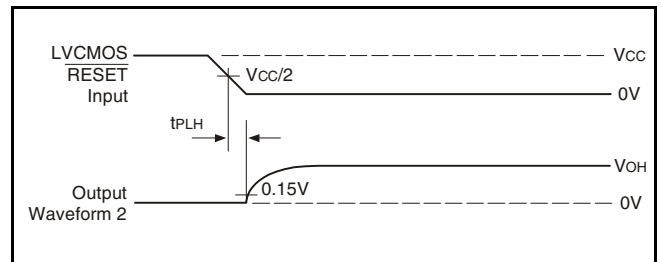
Load Circuit: High-to-Low Slew-Rate Adjustment



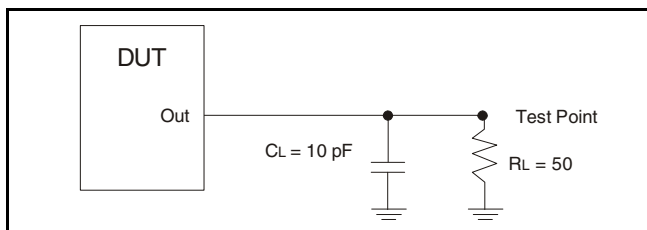
Voltage Waveforms: High-to-Low Slew-Rate Adjustment



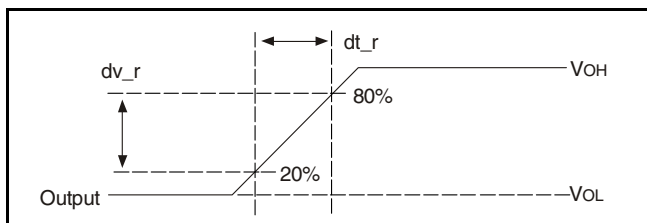
Load Circuit: Error Output Measurements



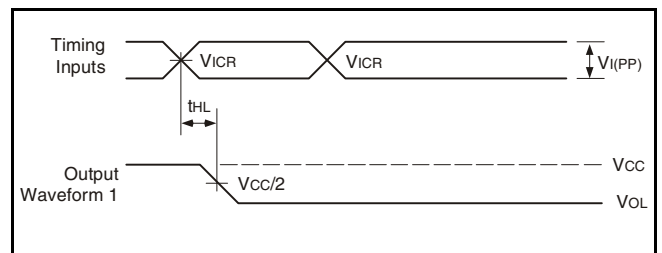
Voltage Waveforms: Open Drain Output Low-to-High Transition Time (with respect to RESET input)



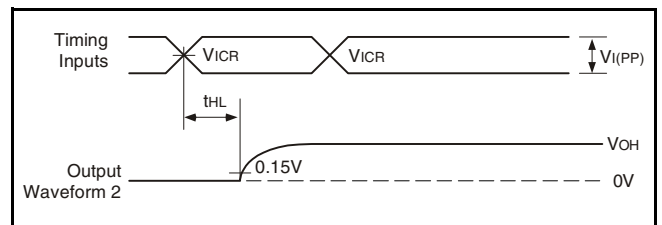
Load Circuit: Low-to-High Slew-Rate Adjustment



Voltage Waveforms: Low-to-High Slew-Rate Adjustment



Voltage Waveforms: Open Drain Output High-to-Low Transition Time (with respect to clock inputs)

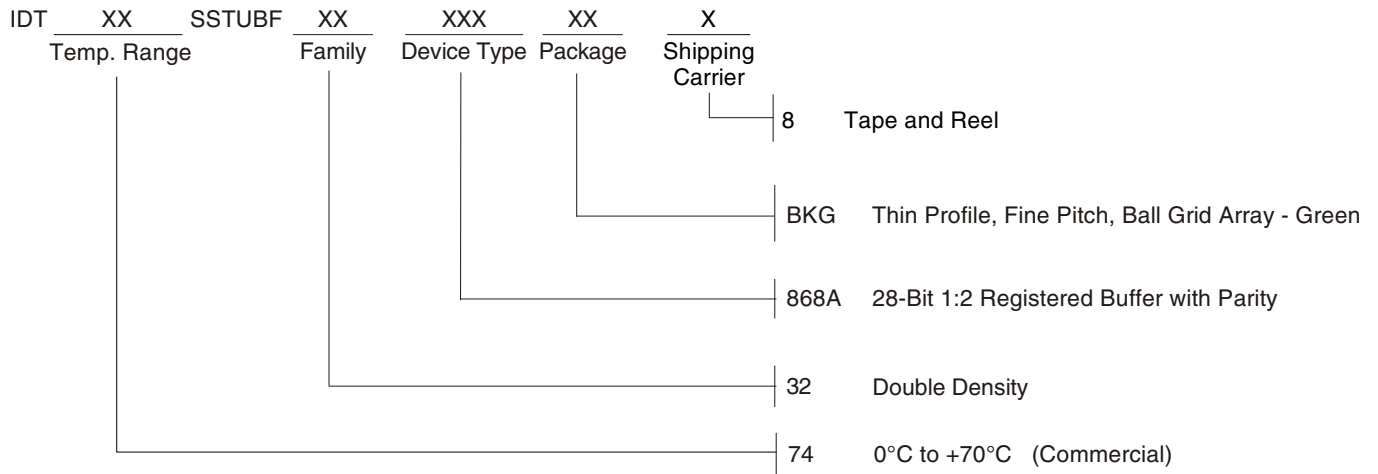


Voltage Waveforms: Open Drain Output Low-to-High Transition Time (with respect to clock inputs)

NOTES:

1. C_L includes probe and jig capacitance.
2. All input pulses are supplied by generators having the following characteristics: PRR $\leq 10\text{MHz}$, $Z_o = 50\Omega$, input slew rate = $1\text{ V/ns} \pm 20\%$ (unless otherwise specified).

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